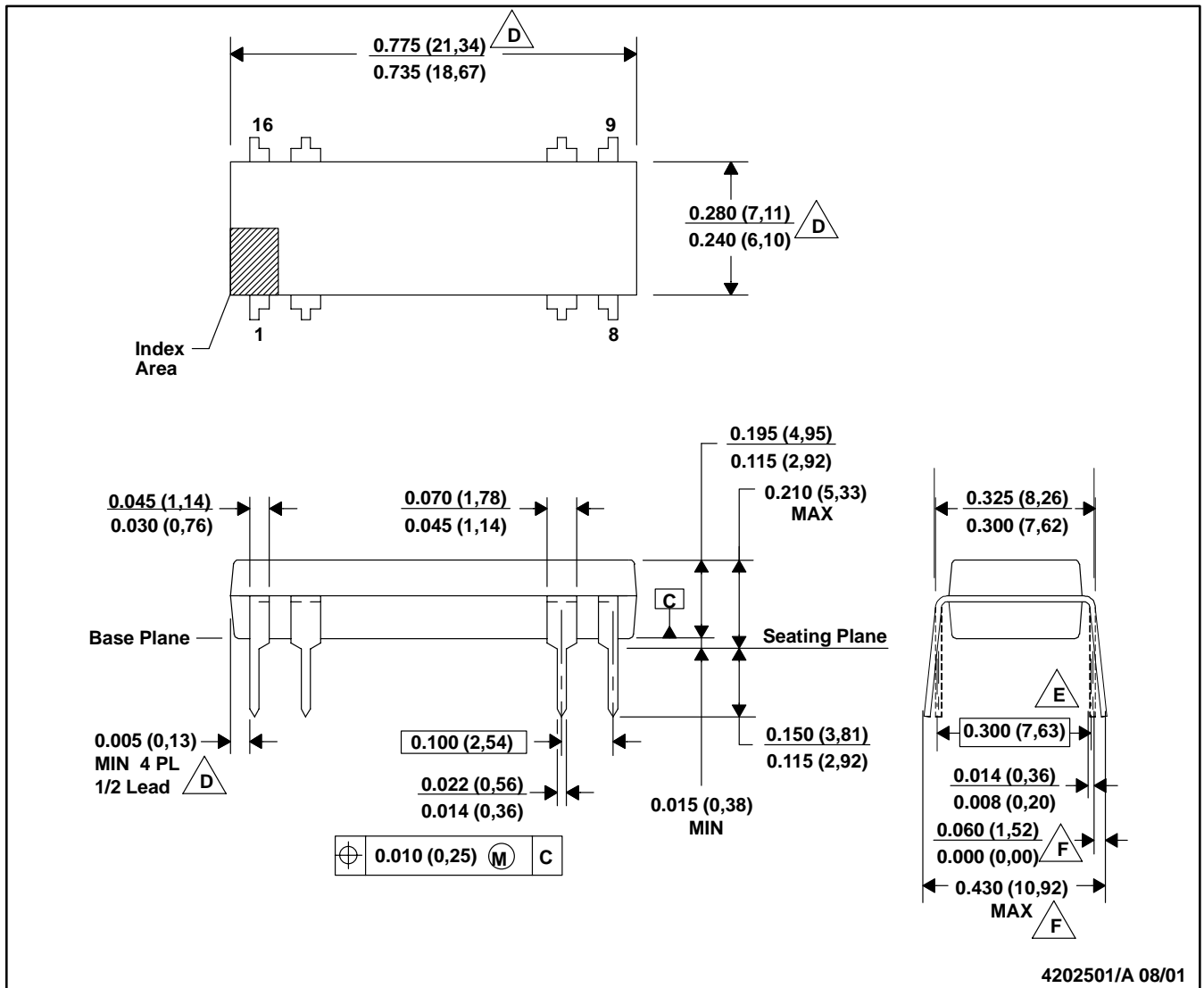


NVF (R-PDIP-T8/16)

PLASTIC DUAL-IN-LINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001-BB with the exception of lead count.
- $\triangle D$. Dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010 (0,25).
- $\triangle E$. Dimensions measured with the leads constrained to be perpendicular to Datum C.
- $\triangle F$. Dimensions are measured at the lead tips with the leads unconstrained.
- G. A visual index feature must be located within the cross-hatched area.

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